



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!




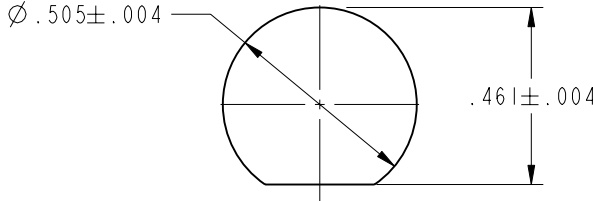
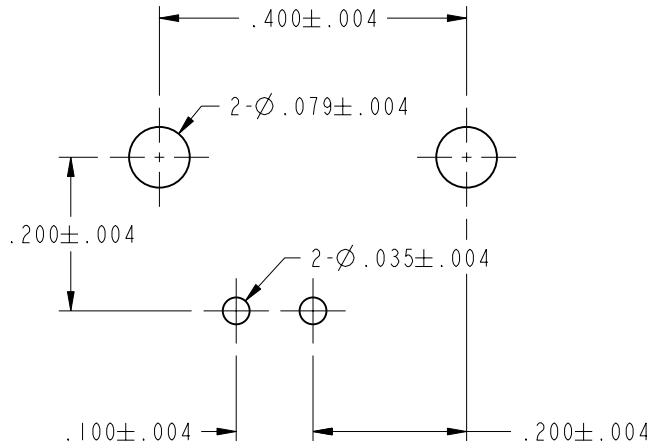
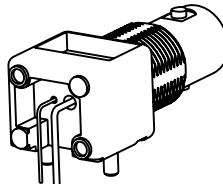
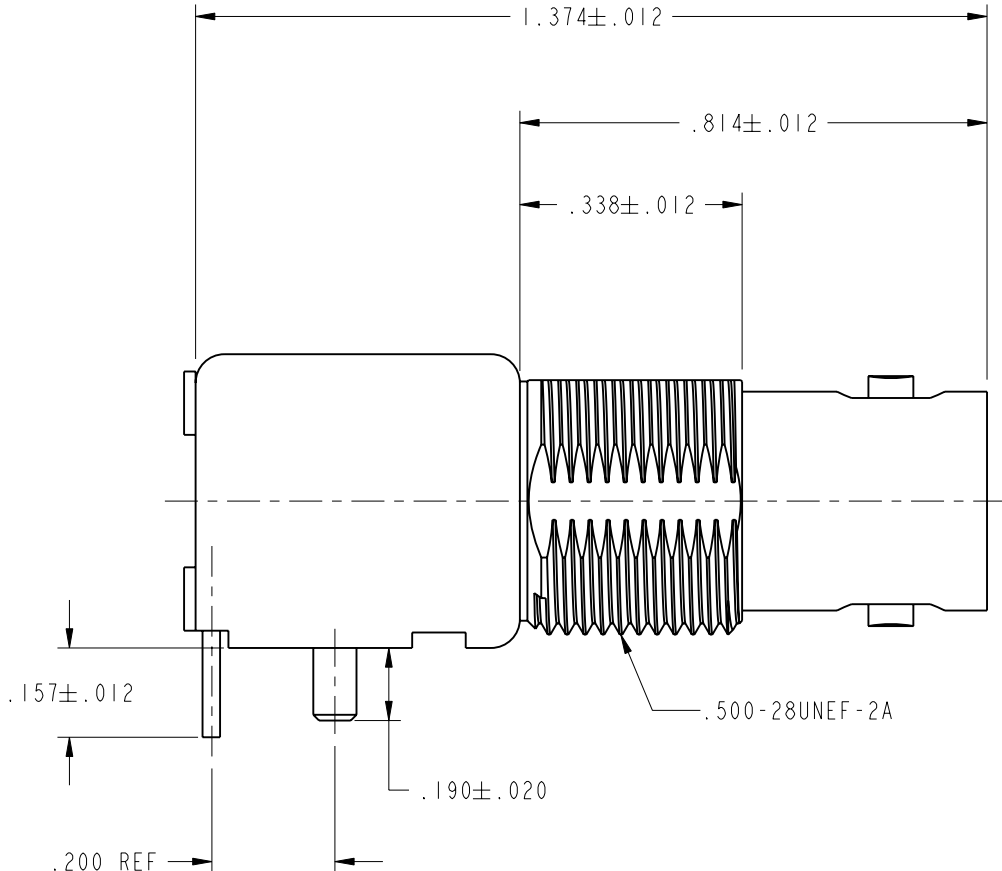
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NOTES:		31-71043		REVISIONS											
1. MATERIALS AND FINISHES: BODY - ZINC DIE CAST, NICKEL PLATED [.000150 MIN THICK] CONTACT - PHOSPHOR BRONZE, GOLD PLATED [.000003 MIN THICK], OVER TIN PLATING [.000100 MIN THICK], OVER NICKEL PLATING [.000050 MIN THICK] GOLD PLATING AT CONTACT AREA, AND TIN OVER NICKEL PLATING OVER ALL INSULATOR - POLYPROPYLENE, UL94V-0 GROUND TER. - COPPER WIRE, TIN PLATED [.000100 MIN THICK] LEGS - BRASS, TIN PLATED [.000100 MIN THICK] 2. ELECTRICAL: A. IMPEDANCE: 75 OHM 3. PACKAGING: A. QUANTITY: BULK PACK OF 50 PER TRAY B. MARKING : BAG TO BE MARKED "AMPHENOL, 31-71043, AND DATE CODE"		DRAWING NO.		REV	DESCRIPTION	DATE	ECO	APPR							
		THIRD ANGLE PROJ. 		A	RELEASE TO MFG.	8/20/98	42607	CPM							
				B	SEE SHEET 1	3/03/05	45392	CPM							
				C	SEE SHEET 1	7/29/08	47082	VC							
				D	SEE SHEET 1	10/7/08	46939	CPM							
<div><div><p>RECOMMENDED PANEL CUTOUT</p><p>SCALE 2.000</p><p>RECOMMENDED P.C.B LAYOUT</p></div><div><p>SCALE 1.000</p></div></div> <div></div> <div>CUSTOMER OUTLINE DRAWING ALL OTHER SHEETS ARE FOR INTERNAL USE ONLY</div>															
UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN INCHES AND TOLERANCES ARE: 2 PLACE DECIMAL 3 PLACE DECIMAL ±.015 (0,381 mm) ±.005 (0,127 mm) ANGLES ± 1° NOTICE - These drawings, specifications, or other data (1) are, and remain the property of Amphenol Corp. (2) must be returned upon request; and (3) are confidential and not to be disclosed to any person other than those to whom they are given by Amphenol Corp. The furnishing of these drawings, specifications, or other data by Amphenol Corp., or to any other person to anyone for any purpose is not to be regarded by implication or otherwise in any manner licensing, granting rights or permitting such holder or any other person to manufacture, use or sell any product, process or design, patented or otherwise, that may in any way be related to or disclosed by said drawings, specifications, or other data.		MATERIAL		DRAWN VIVEK.C		DATE 15-May-08		TITLE BNC JACK, 75 OHM R/A PCB MOUNT ZINC DIE CAST		Amphenol RF Danbury, CT, USA Tainan, Taiwan Shenzhen, China www.amphenolrf.com					
		REFERENCE EAR# 2272		ENGINEER VIVEK.C		DATE 15-May-08									
				APPROVED K. CAPOZZI		DATE 7/29/08									
				CAD FILE I:\BNC\31-71043			CODE ID 74868	DWG SIZE B	DRAWING NO. 31-71043	SCALE: 3.0:1 SHEET 2 OF 2					
										REV D					